

1. General description

Planar passivated high commutation three quadrant triac in a SOT78D (TO-220AB) internally insulated plastic package intended for use in circuits where high static and dynamic dV/dt and high dl/dt can occur. This "series C" triac will commutate the full RMS current at the maximum rated junction temperature without the aid of a snubber. This device has an internally isolated mounting base.

2. Features and benefits

- 3Q technology for improved noise immunity
- High commutation capability with maximum false trigger immunity
- High immunity to false turn-on by dV/dt
- Isolated mounting base with 2500 V (RMS) isolation
- · Less sensitive gate for high noise immunity
- Planar passivated for voltage ruggedness and reliability
- Triggering in three quadrants only

3. Applications

- Electronic thermostats (heating and cooling)
- Motor controls
- Rectifier-fed DC inductive loads e.g. DC motors and solenoids

4. Quick reference data

Table 1. Quick reference data

Parameter	Conditions			_		
	oonanions		Min	Тур	Max	Unit
repetitive peak off- state voltage			-	-	800	V
RMS on-state current	full sine wave; T _{mb} ≤ 84 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>		-	-	12	A
non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4</u> ; <u>Fig. 5</u>		-	-	100	A
	full sine wave; T _{j(init)} = 25 °C; t _p = 16.7 ms		-	-	110	A
junction temperature			-	-	125	°C
eristics	- -					
gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>		2	-	35	mA
	V _D = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u>		2	-	35	mA
	state voltage RMS on-state current non-repetitive peak on- state current junction temperature eristics	$\label{eq:state voltage} \begin{tabular}{ c c c c } \hline state voltage & \\ \hline RMS on-state current & full sine wave; $T_{mb} \le 84 \ ^{\circ}C; $Fig. 1; $Fig. 2; $Fig. 3$ \\ \hline full sine wave; $T_{j(init)} = 25 \ ^{\circ}C; $t_p = 20 \ ms; $Fig. 4; $Fig. 5$ \\ \hline full sine wave; $T_{j(init)} = 25 \ ^{\circ}C; $t_p = 16.7 \ ms$ \\ \hline full sine wave; $T_{j(init)} = 25 \ ^{\circ}C; $t_p = 16.7 \ ms$ \\ \hline eristics & \\ \hline eristics & \\ \hline gate trigger current & $V_D = 12 \ V; \ I_T = 0.1 \ A; $T2+ G+; $T_j = 25 \ ^{\circ}C; $Fig. 7$ \\ \hline V_D = 12 \ V; \ I_T = 0.1 \ A; $T2+ G-; $ \\ \hline \end{array}$	$\label{eq:state voltage} \begin{array}{ c c c } state voltage & & & & & & & & & & & & & & & & & & &$		$ \begin{array}{ c c c c c c } \mbox{state voltage} & & & & & & & & & & & & & & & & & & &$	state voltage VD VD State voltage VD VD State voltage VD V

BTA312Y-800C

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u>	2	-	35	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	35	mA
V _T	on-state voltage	I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
Dynamic cha	aracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
dI _{com} /dt	rate of change of commutating current	V_D = 400 V; T _j = 125 °C; I _{T(RMS)} = 12 A; dV _{com} /dt = 20 V/µs; (snubberless condition); gate open circuit	20	-	-	A/ms

5. Pinning information

Table 2.	Pinning in	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T1	main terminal 1	mb	T2-71
2	T2	main terminal 2		G sym051
3	G	gate		Symost
mb	n.c.	mounting base; isolated		
			1 2 3 TO-220AB (SOT78D)	

6. Ordering information

Table 3. Ordering information						
Type number	Package	je				
	Name	Description	Version			
BTA312Y-800C	TO-220AB	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220	SOT78D			



3Q Hi-Com Triac

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{mb} \le 84 \text{ °C}$; Fig. 1; Fig. 2; Fig. 3	-	12	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig. 4; Fig. 5	-	100	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	110	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	50	A²s
dl _T /dt	rate of rise of on-state current	I _G = 0.2 A	-	100	A/µs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	125	°C
T _i	junction temperature		-	125	°C

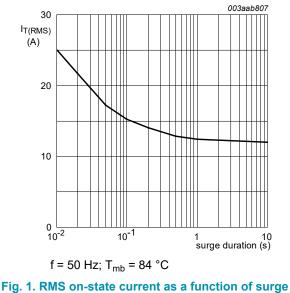


Fig. 1. RMS on-state current as a function of surg duration; maximum values

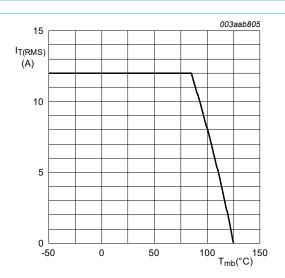
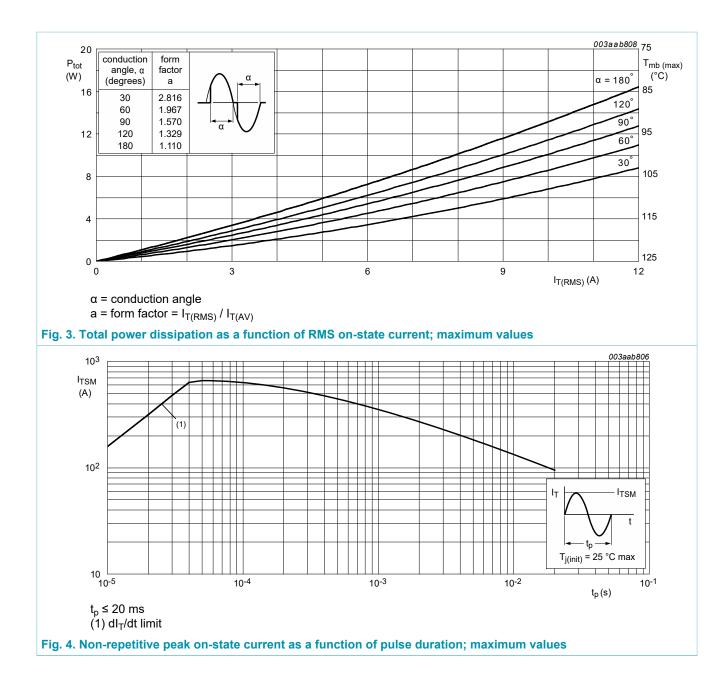


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values

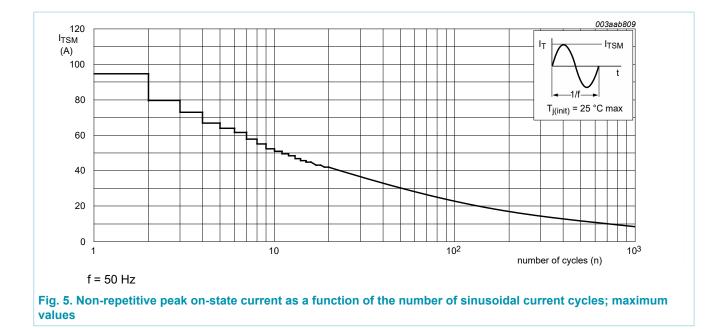
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3Q Hi-Com Triac



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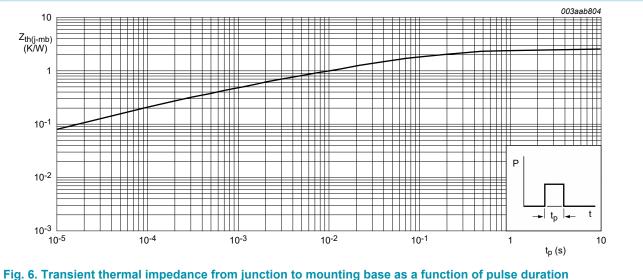


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8. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	full cycle; <u>Fig. 6</u>	-	-	2.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W



9. Isolation characteristics

Table 6. Isolation characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{isol(RMS)}	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _{mb} = 25 °C		-	-	2500	V	
C _{isol}	isolation capacitance	from main terminal 2 to external heatsink; f = 1 MHz; T _{mb} = 25 °C		-	10	-	pF	

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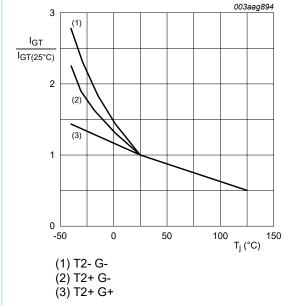


10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics		·			
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>	2	-	35	mA
		V _D = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u>	2	-	35	mA
		V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u>	2	-	35	mA
IL la	latching current	V _D = 12 V; I _G = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 8</u>	-	-	50	mA
		V _D = 12 V; I _G = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	60	mA
		V _D = 12 V; I _G = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	50	mA
Н	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	35	mA
V _T	on-state voltage	I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 11</u>	-	0.8	1	V
		V _D = 400 V; I _T = 0.1 A; T _j = 125 °C; Fig. 11	0.25	0.4	-	V
I _D	off-state current	V _D = 800 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic ch	aracteristics	·				-
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	V_D = 400 V; T _j = 125 °C; I _{T(RMS)} = 12 A; dV _{com} /dt = 20 V/µs; (snubberless condition); gate open circuit	20	-	-	A/ms
l _{gt}	gate-controlled turn-on time	I_{TM} = 20 A; V _D = 800 V; I _G = 0.1 A; dI _G / dt = 5 A/µs	-	2	-	μs

BTA312Y-800C

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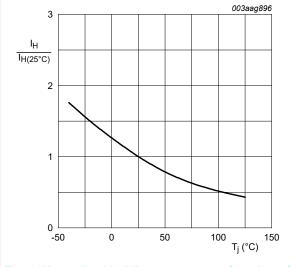
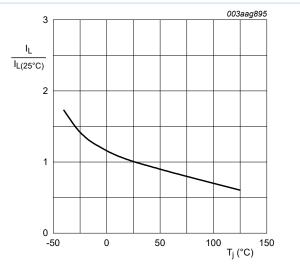
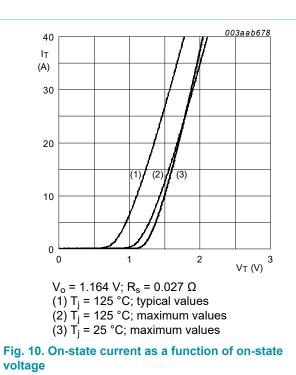


Fig. 9. Normalized holding current as a function of junction temperature

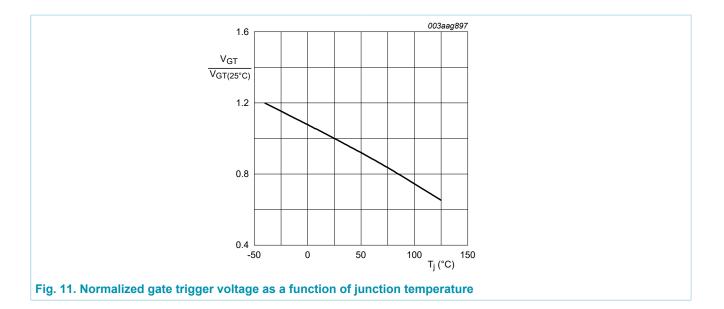






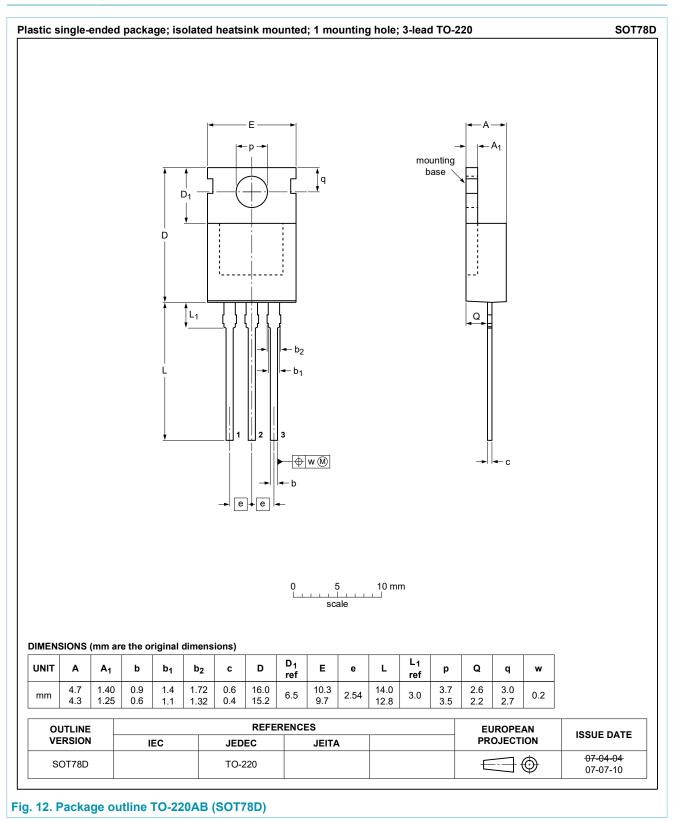
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3Q Hi-Com Triac





11. Package outline



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BTA312Y-800C

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Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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BTA312Y-800C

13. Contents

1.	General description1	
2.	Features and benefits1	
3.	Applications1	
4.	Quick reference data1	
5.	Pinning information2	2
6.	Ordering information2	2
7.	Limiting values	;
8.	Thermal characteristics	;
9.	Isolation characteristics6	;
10.	Characteristics7	,
11.	Package outline10)
12.	Legal information11	

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